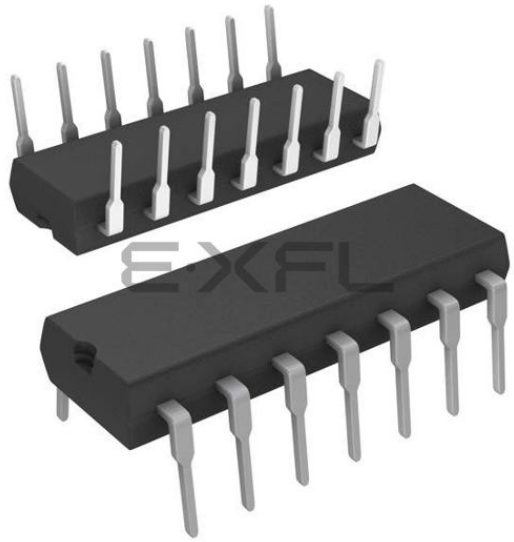

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	12
Program Memory Size	28KB (16K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 11x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	14-DIP (0.300", 7.62mm)
Supplier Device Package	14-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f18326-i-p

TABLE 4-4: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-31 (CONTINUED)

Address	Name	PIC16(L)F18326	PIC16(L)F18346	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
Bank 29													
CPU CORE REGISTERS; see Table 4-2 for specifics													
EA0h	RC0PPS			—	—	—	RC0PPS<4:0>					---0 0000	---u uuuu
EA1h	RC1PPS			—	—	—	RC1PPS<4:0>					---0 0000	---u uuuu
EA2h	RC2PPS			—	—	—	RC2PPS<4:0>					---0 0000	---u uuuu
EA3h	RC3PPS			—	—	—	RC3PPS<4:0>					---0 0000	---u uuuu
EA4h	RC4PPS			—	—	—	RC4PPS<4:0>					---0 0000	---u uuuu
EA5h	RC5PPS			—	—	—	RC5PPS<4:0>					---0 0000	---u uuuu
EA6h	RC6PPS	X	—	Unimplemented								—	—
		—	X	—	—	—	RC6PPS<4:0>					---0 0000	---u uuuu
EA7h	RC7PPS	X	—	Unimplemented								—	—
		—	X	—	—	—	RC7PPS<4:0>					---0 0000	---u uuuu

Legend: x = unknown, u = unchanged, q = depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

Note 1: Only on PIC16F18326/18346.

2: Register accessible from both User and ICD Debugger.

5.7 Register Definitions: Device and Revision

REGISTER 5-5: DEVID: DEVICE ID REGISTER

R	R	R	R	R	R
DEV<13:8>					
bit 13					bit 8

R	R	R	R	R	R	R	R
DEV<7:0>							
bit 7							bit 0

Legend:	
R = Readable bit	
'1' = Bit is set	'0' = Bit is cleared

bit 13-0 **DEV<13:0>:** Device ID bits

Device	DEVID<13:0> Values
PIC16F18326	11 0000 1010 0100 (30A4)
PIC16LF18326	11 0000 1010 0110 (30A6)
PIC16F18346	11 0000 1010 0101 (30A5)
PIC16LF18346	11 0000 1010 0111 (30A7)

REGISTER 5-6: REVID: REVISION ID REGISTER

R-1	R-0	R	R	R	R
REV<13:8>					
bit 13					bit 8

R	R	R	R	R	R	R	R
REV<7:0>							
bit 7							bit 0

Legend:	
R = Readable bit	
'1' = Bit is set	'0' = Bit is cleared

bit 13-0 **REV<13:0>:** Revision ID bits

Note: The upper two bits of the Revision ID Register will always read '10'.

6.0 RESETS

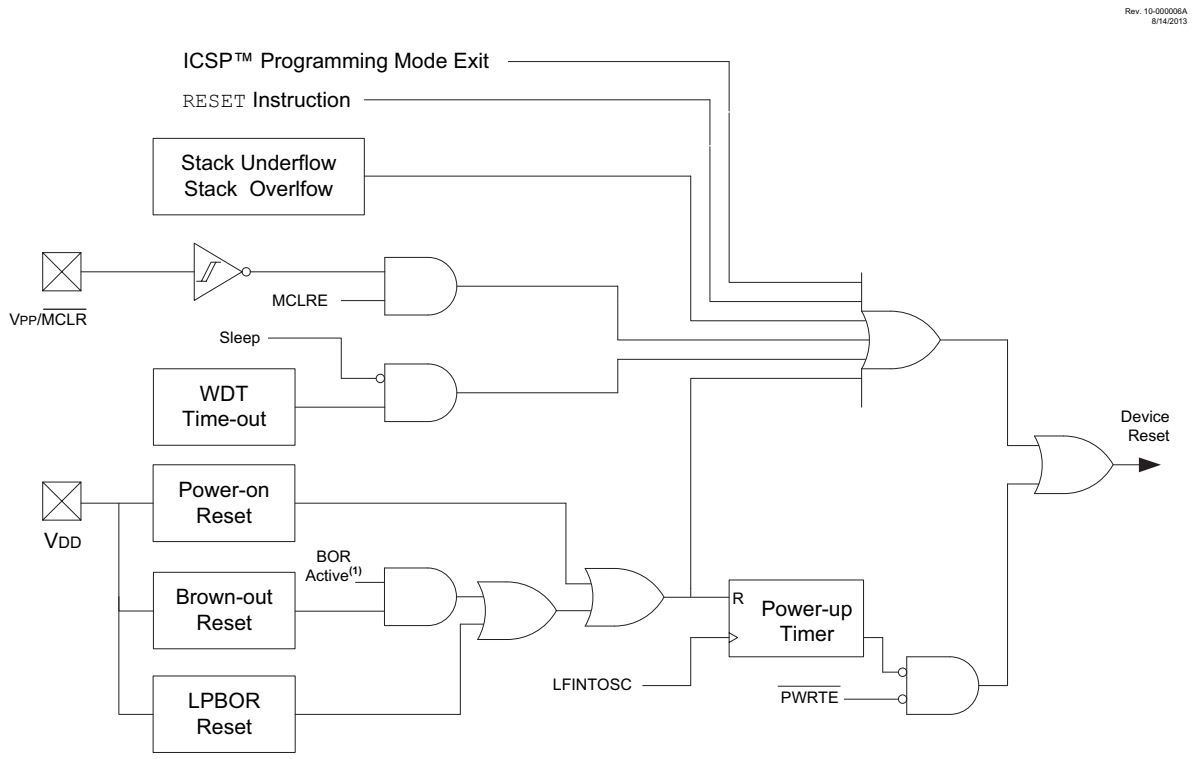
There are multiple ways to reset this device:

- Power-On Reset (POR)
- Brown-Out Reset (BOR)
- Low-Power Brown-Out Reset (LPBOR)
- MCLR Reset
- WDT Reset
- RESET instruction
- Stack Overflow
- Stack Underflow
- Programming mode exit

To allow VDD to stabilize, an optional Power-up Timer can be enabled to extend the Reset time after a BOR or POR event.

A simplified block diagram of the on-chip Reset circuit is shown in Figure 6-1.

FIGURE 6-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



Note 1: See Table 6-1 for BOR active conditions.

6.1 Power-on Reset (POR)

The POR circuit holds the device in Reset until VDD has reached an acceptable level for minimum operation. Slow rising VDD, fast operating speeds or analog performance may require greater than minimum VDD. The PWRT, BOR or MCLR features can be used to extend the start-up period until all device operation conditions have been met.

6.2 Brown-out Reset (BOR)

The BOR circuit holds the device in Reset while VDD is below a selectable minimum level. Between the POR and BOR, complete voltage range coverage for execution protection can be implemented.

The Brown-out Reset module has four operating modes controlled by the BOREN<1:0> bits in Configuration Words. The four operating modes are:

- BOR is always on
- BOR is off when in Sleep
- BOR is controlled by software
- BOR is always off

Refer to Table 6-1 for more information.

The Brown-out Reset voltage level is selectable by configuring the BORV bit in Configuration Words.

A VDD noise rejection filter prevents the BOR from triggering on small events. If VDD falls below VBOR for a duration greater than parameter TBORDC, the device will reset, and the BOR bit of the PCON0 register will be cleared, indicating that a Brown-out Reset condition occurred. See Figure 6-2 for more information.

TABLE 6-1: BOR OPERATING MODES

BOREN<1:0>	SBOREN	Device Mode	BOR Mode	Instruction Execution upon: Release of POR or Wake-up from Sleep
11	X	X	Active	In these specific cases, “Release of POR” and “Wake-up from Sleep”, there is no delay in start-up. The BOR ready flag, (BORRDY = 1), will be set before the CPU is ready to execute instructions because the BOR circuit is forced on by the BOREN<1:0> bits.
10	X	Awake	Active	Waits for release of BOR (BORRDY = 1)
		Sleep	Disabled	BOR ignored when asleep
01	1	X	Active	In these specific cases, “Release of POR” and “Wake-up from Sleep”, there is no delay in start-up. The BOR ready flag, (BORRDY = 1), will be set before the CPU is ready to execute instructions because the BOR circuit is forced on by the BOREN<1:0> bits
	0	X	Disabled	Begins immediately (BORRDY = x)
00	X	X	Disabled	

6.11 Determining the Cause of a Reset

Upon any Reset, multiple bits in the STATUS and PCON registers are updated to indicate the cause of the Reset. Table 6-3 and Table 6-4 show the Reset conditions of these registers.

TABLE 6-3: RESET STATUS BITS AND THEIR SIGNIFICANCE

STKOVF	STKUNF	$\overline{\text{RWDT}}$	$\overline{\text{RMCLR}}$	$\overline{\text{RI}}$	$\overline{\text{POR}}$	$\overline{\text{BOR}}$	$\overline{\text{TO}}$	$\overline{\text{PD}}$	Condition
0	0	1	1	1	0	x	1	1	Power-on Reset
0	0	1	1	1	0	x	0	x	Illegal, $\overline{\text{TO}}$ is set on $\overline{\text{POR}}$
0	0	1	1	1	0	x	x	0	Illegal, $\overline{\text{PD}}$ is set on $\overline{\text{POR}}$
0	0	u	1	1	u	0	1	1	Brown-out Reset
u	u	0	u	u	u	u	0	u	WDT Reset
u	u	u	u	u	u	u	0	0	WDT Wake-up from Sleep
u	u	u	u	u	u	u	1	0	Interrupt Wake-up from Sleep
u	u	u	0	u	u	u	u	u	$\overline{\text{MCLR}}$ Reset during Normal Operation
u	u	u	0	u	u	u	1	0	$\overline{\text{MCLR}}$ Reset during Sleep
u	u	u	u	0	u	u	u	u	RESET Instruction Executed
1	u	u	u	u	u	u	u	u	Stack Overflow Reset (STVREN = 1)
u	1	u	u	u	u	u	u	u	Stack Underflow Reset (STVREN = 1)

TABLE 6-4: RESET CONDITION FOR SPECIAL REGISTERS

Condition	Program Counter	STATUS Register	PCON0 Register
Power-on Reset	0000h	---1 1000	00-- 110x
$\overline{\text{MCLR}}$ Reset during Normal Operation	0000h	---u uuuu	uu-- 0uuu
$\overline{\text{MCLR}}$ Reset during Sleep	0000h	---1 0uuu	uu-- 0uuu
WDT Reset	0000h	---0 uuuu	uu-0 uuuu
WDT Wake-up from Sleep	PC + 1	---0 0uuu	uu-u uuuu
Brown-out Reset	0000h	---1 1000	00-1 11u0
Interrupt Wake-up from Sleep	PC + 1(1)	---1 0uuu	uu-u uuuu
RESET Instruction Executed	0000h	---u uuuu	uu-u u0uu
Stack Overflow Reset (STVREN = 1)	0000h	---u uuuu	1u-u uuuu
Stack Underflow Reset (STVREN = 1)	0000h	---u uuuu	u1-u uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0'.

Note 1: When the wake-up is due to an interrupt and Global Enable bit (GIE) is set, the return address is pushed on the stack and PC is loaded with the interrupt vector (0004h) after execution of PC + 1.

7.5 Register Definitions: Oscillator Control

REGISTER 7-1: OSCCON1: OSCILLATOR CONTROL REGISTER 1

U-0	R/W-f/f(1)	R/W-f/f(1)	R/W-f/f(1)	R/W-q/q(4)	R/W-q/q(4)	R/W-q/q(4)	R/W-q/q(4)
—	NOSC<2:0>(2,3)			NDIV<3:0>(2,3)			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	f = determined by fuse setting
q = Reset value is determined by hardware		

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **NOSC<2:0>:** New Oscillator Source Request bits
The setting requests a source oscillator and PLL combination per Table 7-1.
POR value = RSTOSC (Register 5-2).

bit 3-0 **NDIV<3:0>:** New Divider Selection Request bits
The setting determines the new postscaler division ratio per Table 7-2.

Note 1: The default value (f/f) is set equal to the RSTOSC Configuration bits.
2: If NOSC is written with a reserved value (Table 7-1), the HFINTOSC will be automatically selected as the clock source.
3: When CSWEN = 0, this register is read-only and cannot be changed from the POR value.
4: When RSTOSC = 110 (HFINTOSC 1 MHz) the NDIV bits will default to '0010' upon Reset; for all other NOSC settings, the NVID bits will default to '0000' upon Reset.

REGISTER 7-2: OSCCON2: OSCILLATOR CONTROL REGISTER 2

U-0	R-q/q(1)	R-q/q(1)	R-q/q(1)	R-q/q(1)	R-q/q(1)	R-q/q(1)	R-q/q(1)
—	COSC<2:0>			CDIV<3:0>			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	q = Reset value is determined by hardware

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **COSC<2:0>:** Current Oscillator Source Select bits (read-only)
Indicates the current source oscillator and PLL combination per Table 7-1.

bit 3-0 **CDIV<3:0>:** Current Divider Select bits (read-only)
Indicates the current postscaler division ratio per Table 7-2.

Note 1: The Reset value (q/q) will match the NOSC<2:0>/NDIV<3:0> bits.

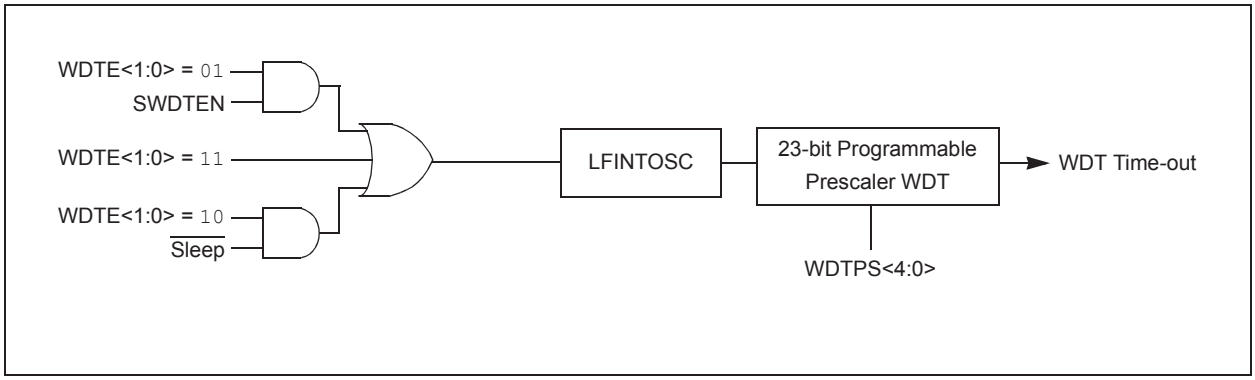
10.0 WATCHDOG TIMER (WDT)

The Watchdog Timer is a system timer that generates a Reset if the firmware does not issue a CLRWDT instruction within the time-out period. The Watchdog Timer is typically used to recover the system from unexpected events.

The WDT has the following features:

- Independent clock source
- Multiple operating modes
  - WDT is always ON
  - WDT is OFF when in Sleep
  - WDT is controlled by software
  - WDT is always OFF
- Configurable time-out period is from 1 ms to 256 seconds (nominal)
- Multiple WDT clearing conditions
- Operation during Sleep

FIGURE 10-1: WATCHDOG TIMER BLOCK DIAGRAM



17.0 TEMPERATURE INDICATOR MODULE

This family of devices is equipped with a temperature circuit designed to measure the operating temperature of the silicon die. The circuit's range of operating temperature falls between -40°C and +85°C. The output is a voltage that is proportional to the device temperature. The output of the temperature indicator is internally connected to the device ADC.

The circuit may be used as a temperature threshold detector or a more accurate temperature indicator, depending on the level of calibration performed. A one-point calibration allows the circuit to indicate a temperature closely surrounding that point. A two-point calibration allows the circuit to sense the entire range of temperature more accurately. Reference Application Note AN2092, *"Using the Temperature Indicator Module"* (DS00002092) for more details regarding the calibration process.

17.1 Circuit Operation

Figure 17-1 shows a simplified block diagram of the temperature circuit. The proportional voltage output is achieved by measuring the forward voltage drop across multiple silicon junctions.

Equation 17-1 describes the output characteristics of the temperature indicator.

EQUATION 17-1: VOUT RANGES

$$\text{High Range: } V_{OUT} = V_{DD} - 4V_T$$

$$\text{Low Range: } V_{OUT} = V_{DD} - 2V_T$$

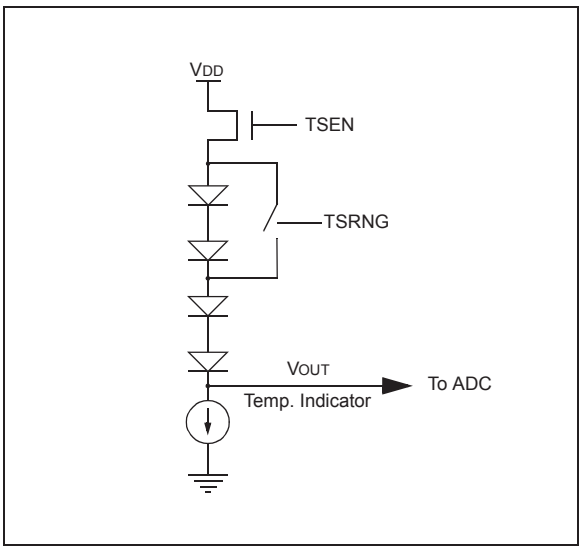
The temperature sense circuit is integrated with the Fixed Voltage Reference (FVR) module. See **Section 16.0 "Fixed Voltage Reference (FVR)"** for more information.

The circuit is enabled by setting the TSEN bit of the FVRCON register. When disabled, the circuit draws no current.

The circuit operates in either high or low range. The high range, selected by setting the TSRNG bit of the FVRCON register, provides a wider output voltage. This provides more resolution over the temperature range. This range requires a higher bias voltage to operate and thus, a higher VDD is needed.

The low range is selected by clearing the TSRNG bit of the FVRCON register. The low range generates a lower voltage drop and thus, a lower VDD voltage is needed to operate the circuit. The low range is provided for low voltage operation.

FIGURE 17-1: TEMPERATURE CIRCUIT DIAGRAM



17.2 Minimum Operating VDD

When the temperature circuit is operated in low range, the device may be operated at any operating voltage that is within specifications.

When the temperature circuit is operated in high range, the device operating voltage, VDD, must be high enough to ensure that the temperature circuit is correctly biased.

Table 17-1 shows the recommended minimum VDD vs. range setting.

TABLE 17-1: RECOMMENDED VDD VS. RANGE

Min. VDD, TSRNG = 1	Min. VDD, TSRNG = 0
3.6V	1.8V

17.3 Temperature Output

The output of the circuit is measured using the internal Analog-to-Digital Converter. A channel is provided for the temperature circuit output. Refer to **Section 22.0 "Analog-to-Digital Converter (ADC) Module"** for detailed information.

TABLE 19-3: SUMMARY OF REGISTERS ASSOCIATED WITH PWMx

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
TRISA	—	—	TRISA5	TRISA4	—(2)	TRISA2	TRISA1	TRISA0	143
ANSELA	—	—	ANSA5	ANSA4	—	ANSA2	ANSA1	ANSA0	144
TRISB(1)	TRISB7	TRISB6	TRISB5	TRISB4	—	—	—	—	149
ANSELB(1)	ANSB7	ANSB6	ANSB5	ANSB4	—	—	—	—	150
TRISC	TRISC7(1)	TRISC6(1)	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	155
ANSELC	ANSC7(1)	ANSC6(1)	ANSC5	ANSC4	ANSC3	ANSC2	ANSC1	ANSC0	157
PWM5CON	PWM5EN	—	PWM5OUT	PWM5POL	—	—	—	—	196
PWM5DCH	PWM5DC<9:2>								196
PWM5DCL	PWM5DC<1:0>		—	—	—	—	—	—	196
PWM6CON	PWM6EN	—	PWM6OUT	PWM6POL	—	—	—	—	196
PWM6DCH	PWM6DC<9:2>								196
PWM6DCL	PWM6DC<1:0>		—	—	—	—	—	—	196
PWMTMRS	—	—	—	—	P6TSEL<1:0>		P5TSEL<1:0>		197
INTCON	GIE	PEIE	—	—	—	—	—	INTEDG	100
PIR1	TMR1GIF	ADIF	RCIF	TXIF	SSP1IF	BCL1IF	TMR2IF	TMR1IF	107
PIR2	TMR6IF	C2IF	C1IF	NVMIF	SSP2IF	BCL2IF	TMR4IF	NCO1IF	108
PIE1	TMR1GIE	ADIE	RCIE	TXIE	SSP1IE	BCL1IE	TMR2IE	TMR1IE	102
PIE2	TMR6IE	C2IE	C1IE	NVMIE	SSP2IE	BCL2IE	TMR4IE	NCO1IE	103
T2CON	—	T2OUTPS<3:0>				TMR2ON	T2CKPS<1:0>		298
T4CON	—	T4OUTPS<3:0>				TMR4ON	T4CKPS<1:0>		292
T6CON	—	T6OUTPS<3:0>				TMR6ON	T6CKPS<1:0>		292
TMR2	TMR2<7:0>								299
TMR4	TMR4<7:0>								299
TMR6	TMR6<7:0>								299
PR2	PR2<7:0>								299
PR4	PR4<7:0>								299
PR6	PR6<7:0>								299
CWGxDAT	—	—	—	—	DAT<3:0>				215
CLCxSELy	—	—	LCxDyS<5:0>						229
MDSRC	—	—	—	—	MDMS<3:0>				272
MDCARH	—	MDCHPOL	MDCHSYNC	—	MDCH<3:0>				273
MDCARL	—	MDCLPOL	MDCLSYNC	—	MDCL<3:0>				274

Legend: – = Unimplemented locations, read as '0'. Shaded cells are not used by the PWM module.

Note 1: PIC16(L)F18346 only.

2: Unimplemented, read as '1'.

REGISTER 21-10: CLCxGLS3: GATE 3 LOGIC SELECT REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
LCxG4D4T	LCxG4D4N	LCxG4D3T	LCxG4D3N	LCxG4D2T	LCxG4D2N	LCxG4D1T	LCxG4D1N
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **LCxG4D4T:** Gate 3 Data 4 True (non-inverted) bit
1 = CLCIN3 (true) is gated into CLCx Gate 3
0 = CLCIN3 (true) is not gated into CLCx Gate 3

bit 6 **LCxG4D4N:** Gate 3 Data 4 Negated (inverted) bit
1 = CLCIN3 (inverted) is gated into CLCx Gate 3
0 = CLCIN3 (inverted) is not gated into CLCx Gate 3

bit 5 **LCxG4D3T:** Gate 3 Data 3 True (non-inverted) bit
1 = CLCIN2 (true) is gated into CLCx Gate 3
0 = CLCIN2 (true) is not gated into CLCx Gate 3

bit 4 **LCxG4D3N:** Gate 3 Data 3 Negated (inverted) bit
1 = CLCIN2 (inverted) is gated into CLCx Gate 3
0 = CLCIN2 (inverted) is not gated into CLCx Gate 3

bit 3 **LCxG4D2T:** Gate 3 Data 2 True (non-inverted) bit
1 = CLCIN1 (true) is gated into CLCx Gate 3
0 = CLCIN1 (true) is not gated into CLCx Gate 3

bit 2 **LCxG4D2N:** Gate 3 Data 2 Negated (inverted) bit
1 = CLCIN1 (inverted) is gated into CLCx Gate 3
0 = CLCIN1 (inverted) is not gated into CLCx Gate 3

bit 1 **LCxG4D1T:** Gate 3 Data 1 True (non-inverted) bit
1 = CLCIN0 (true) is gated into CLCx Gate 3
0 = CLCIN0 (true) is not gated into CLCx Gate 3

bit 0 **LCxG4D1N:** Gate 3 Data 1 Negated (inverted) bit
1 = CLCIN0 (inverted) is gated into CLCx Gate 3
0 = CLCIN0 (inverted) is not gated into CLCx Gate 3

22.2 ADC Operation

22.2.1 STARTING A CONVERSION

To enable the ADC module, the ADON bit of the ADCON0 register must be set to a '1'. Setting the GO/DONE bit of the ADCON0 register to a '1' will start the Analog-to-Digital conversion.

Note:	The GO/DONE bit will not be set in the same instruction that turns on the ADC. Refer to **Section 22.2.5 "ADC Conversion Procedure"**.

22.2.2 COMPLETION OF A CONVERSION

When the conversion is complete, the ADC module will:

- Clear the GO/DONE bit
- Set the ADIF Interrupt Flag bit
- Update the ADRESH and ADRESL registers with new conversion result

Note:	A device Reset forces all registers to their Reset state. Thus, the ADC module is turned off and any pending conversion is terminated.

22.2.3 ADC OPERATION DURING SLEEP

The ADC module can operate during Sleep. This requires the ADC clock source to be set to the ADCRC option. When the ADCRC oscillator source is selected, the ADC waits one additional instruction before starting the conversion. This allows the SLEEP instruction to be executed, which can reduce system noise during the conversion. If the ADC interrupt is enabled, the device will wake-up from Sleep when the conversion completes. If the ADC interrupt is disabled, the ADC module is turned off after the conversion completes, although the ADON bit remains set.

When the ADC clock source is something other than ADCRC, a SLEEP instruction causes the present conversion to be aborted and the ADC module is turned off, although the ADON bit remains set.

22.2.4 AUTO-CONVERSION TRIGGER

The Auto-conversion Trigger allows periodic ADC measurements without software intervention. When a rising edge of the selected source occurs, the GO/DONE bit is set by hardware.

The Auto-conversion Trigger source is selected with the ADACT<4:0> bits of the ADACT register.

See Table 22-2 for auto-conversion sources.

TABLE 22-2: ADC AUTO-CONVERSION TABLE

Source Peripheral	Description
TMR0	Timer0 Overflow condition
TMR1	Timer1 Overflow condition
TMR3	Timer3 Overflow condition
TMR5	Timer5 Overflow condition
TMR2	Match between Timer2 and PR2
TMR4	Match between Timer4 and PR4
TMR6	Match between Timer6 and PR6
C1	Comparator C1 output
C2	Comparator C2 output
CLC1	CLC1 output
CLC2	CLC2 output
CLC3	CLC3 output
CLC4	CLC4 output
CCP1	CCP1 output
CCP2	CCP2 output
CCP3	CCP3 output
CCP4	CCP4 output

REGISTER 22-2: ADCON1: ADC CONTROL REGISTER 1

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0	R/W-0/0
ADFM	ADCS<2:0>			—	ADNREF	ADPREF<1:0>	
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 **ADFM:** ADC Result Format Select bit
1 = Right justified. Six Most Significant bits of ADRESH are set to '0' when the conversion result is loaded.
0 = Left justified. Six Least Significant bits of ADRESL are set to '0' when the conversion result is loaded.

bit 6-4 **ADCS<2:0>:** ADC Conversion Clock Select bits
111 = ADCRC (dedicated RC oscillator)
110 = FOSC/64
101 = FOSC/16
100 = FOSC/4
011 = ADCRC (dedicated RC oscillator)
010 = FOSC/32
001 = FOSC/8
000 = FOSC/2

bit 3 **Unimplemented:** Read as '0'

bit 2 **ADNREF:** A/D Negative Voltage Reference Configuration bit
When ADON = 0, all multiplexer inputs are disconnected.
0 = VREF- is connected to AVSS
1 = VREF- is connected to external VREF-

bit 1-0 **ADPREF<1:0>:** ADC Positive Voltage Reference Configuration bits
11 = VREF+ is connected to internal Fixed Voltage Reference (FVR) module(1)
10 = VREF+ is connected to external VREF+ pin(1)
01 = Reserved
00 = VREF+ is connected to VDD

Note 1: When selecting the VREF+ pin as the source of the positive reference, be aware that a minimum voltage specification exists. See Table 35-13 for details.

REGISTER 23-2: NCO1CLK: NCO1 INPUT CLOCK CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	U-0	U-0	U-0	R/W-0/0	R/W-0/0
N1PWS<2:0>			—	—	—	N1CKS<1:0>	
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-5 **N1PWS<2:0>:** NCO1 Output Pulse Width Select bits(1, 2)
- 111 = NCO1 output is active for 128 input clock periods
- 110 = NCO1 output is active for 64 input clock periods
- 101 = NCO1 output is active for 32 input clock periods
- 100 = NCO1 output is active for 16 input clock periods
- 011 = NCO1 output is active for 8 input clock periods
- 010 = NCO1 output is active for 4 input clock periods
- 001 = NCO1 output is active for 2 input clock periods
- 000 = NCO1 output is active for 1 input clock period

bit 4-2 **Unimplemented:** Read as ‘0’

bit 1-0 **N1CKS<1:0>:** NCO1 Clock Source Select bits
- 11 =Reserved
- 10 = CLC1OUT
- 01 = FOSC
- 00 = HFINTOSC (16 MHz)

Note 1: N1PWS applies only when operating in Pulse Frequency mode.

2: If NCO1 pulse width is greater than NCO1 overflow period, the NCO1 output does not toggle.

REGISTER 23-3: NCO1ACCL: NCO1 ACCUMULATOR REGISTER – LOW BYTE

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
NCO1ACC<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **NCO1ACC<7:0>:** NCO1 Accumulator, low byte

29.0 CAPTURE/COMPARE/PWM MODULES

The Capture/Compare/PWM module is a peripheral that allows the user to time and control different events and to generate Pulse-Width Modulation (PWM) signals. In Capture mode, the peripheral allows the timing of the duration of an event. The Compare mode allows the user to trigger an external event when a predetermined amount of time has expired. The PWM mode can generate Pulse-Width Modulated signals of varying frequency and duty cycle.

This family of devices contains four standard Capture/Compare/PWM modules (CCP1, CCP2, CCP3 and CCP4).

The Capture and Compare functions are identical for all CCP modules.

29.1 CCP/PWM Clock Selection

The PIC16(L)F18326/18346 devices allow each individual CCP and PWM module to select the timer source that controls the module. Each module has an independent selection.

As there are up to three 8-bit timers with auto-reload (Timer2, Timer4, and Timer6), PWM mode on the CCP and PWM modules can use any of these timers.

The CCPTMRS register is used to select which timer is used.

Note 1:	In devices with more than one CCP module, it is very important to pay close attention to the register names used. A number placed after the module acronym is used to distinguish between separate modules. For example, the CCP1CON and CCP2CON control the same operational aspects of two completely different CCP modules.
2:	Throughout this section, generic references to a CCP module in any of its operating modes may be interpreted as being equally applicable to CCPx module. Register names, module signals, I/O pins, and bit names may use the generic designator ‘x’ to indicate the use of a numeral to distinguish a particular module, when required.

29.2 Capture Mode

Capture mode makes use of either the 16-bit Timer0 or Timer1 resource. When an event occurs on the capture source, the 16-bit CCPRxH:CCPRxL register pair captures and stores the 16-bit value of the TMR0H:TMR0L or TMR1H:TMR1L register pair, respectively. An event is defined as one of the following and is configured by the CCPxMODE<3:0> bits of the CCPxCON register:

- Every falling edge
- Every rising edge
- Every 4th rising edge
- Every 16th rising edge

When a capture is made, the Interrupt Request Flag bit CCPxIF of the PIR4 register is set. The interrupt flag must be cleared in software. If another capture occurs before the value in the CCPRxH, CCPRxL register pair is read, the old captured value is overwritten by the new captured value.

Figure 29-1 shows a simplified diagram of the capture operation.

29.2.1 CAPTURE SOURCES

In Capture mode, the CCPx pin should be configured as an input by setting the associated TRIS control bit.

Note:	If the CCPx pin is configured as an output, a write to the port can cause a Capture condition.

The capture source is selected by configuring the CCPxCTS<3:0> bits of the CCPxCAP register. The following sources can be selected:

- CCPxPPS input
- C1_output
- C2_output
- NCO_output
- IOC_interrupt
- LC1_output
- LC2_output
- LC3_output
- LC4_output

31.6 Register Definitions: EUSART1 Control

REGISTER 31-1: TX1STA: TRANSMIT STATUS AND CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R-1/1	R/W-0/0
CSRC	TX9	TXEN(1)	SYNC	SENDB	BRGH	TRMT	TX9D
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 **CSRC:** Clock Source Select bit
Asynchronous mode:
Unused in this mode – value ignored
Synchronous mode:
1 = Master mode (clock generated internally from BRG)
0 = Slave mode (clock from external source)

bit 6 **TX9:** 9-bit Transmit Enable bit
1 = Selects 9-bit transmission
0 = Selects 8-bit transmission

bit 5 **TXEN:** Transmit Enable bit(1)
1 = Transmit enabled
0 = Transmit disabled

bit 4 **SYNC:** EUSART1 Mode Select bit
1 = Synchronous mode
0 = Asynchronous mode

bit 3 **SENDB:** Send Break Character bit
Asynchronous mode:
1 = Send SYNCH BREAK on next transmission – Start bit, followed by 12 '0' bits, followed by Stop bit; cleared by hardware upon completion
0 = SYNCH BREAK transmission disabled or completed
Synchronous mode:
Unused in this mode – value ignored

bit 2 **BRGH:** High Baud Rate Select bit
Asynchronous mode:
1 = High speed
0 = Low speed
Synchronous mode:
Unused in this mode – value ignored

bit 1 **TRMT:** Transmit Shift Register Status bit
1 = TSR empty
0 = TSR full

bit 0 **TX9D:** Ninth bit of Transmit Data
Can be address/data bit or a parity bit.

Note 1: SREN/CREN overrides TXEN in Sync mode.

TABLE 34-3: PIC16(L)F18326/18346 INSTRUCTION SET (CONTINUED)

Mnemonic, Operands		Description	Cycles	14-bit Opcode MSb	LSb	Status Affected	Notes
INHERENT OPERATIONS							
CLRWDT	–	Clear Watchdog Timer	1	00 0000 0110 0100		$\overline{TO}$, $\overline{PD}$	
NOP	–	No Operation	1	00 0000 0000 0000			
RESET	–	Software device Reset	1	00 0000 0000 0001			
SLEEP	–	Go into Standby mode	1	00 0000 0110 0011		$\overline{TO}$, $\overline{PD}$	
TRIS	f	Load TRIS register with W	1	00 0000 0110 0fff			
C-COMPILER OPTIMIZED							
ADDFSR	n, k	Add Literal k to FSRn	1	11 0001 0nkk kkkk			
MOVIW	n mm	Move Indirect FSRn to W with pre/post inc/dec modifier, mm	1	00 0000 0001 0nmm		Z	**2, 3**
	k[n]	Move INDFn to W, Indexed Indirect.	1	11 1111 0nkk kkkk		Z	**2**
MOVWI	n mm	Move W to Indirect FSRn with pre/post inc/dec modifier, mm	1	00 0000 0001 1nmm			**2, 3**
	k[n]	Move W to INDFn, Indexed Indirect.	1	11 1111 1nkk kkkk			**2**

Note 1: If the Program Counter (PC) is modified, or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

2: If this instruction addresses an INDF register and the MSb of the corresponding FSR is set, this instruction will require one additional instruction cycle.

3: See **Section 34.2 "Instruction Descriptions"** for detailed MOVIW and MOVWI instruction descriptions.

LSLF **Logical Left Shift**

Syntax: [*label*] LSLF f {,d}

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: (f<7>) → C
(f<6:0>) → dest<7:1>
0 → dest<0>

Status Affected: C, Z

Description: The contents of register 'f' are shifted one bit to the left through the Carry flag. A '0' is shifted into the LSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.

LSRF **Logical Right Shift**

Syntax: [*label*] LSRF f {,d}

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: 0 → dest<7>
(f<7:1>) → dest<6:0>,
(f<0>) → C,

Status Affected: C, Z

Description: The contents of register 'f' are shifted one bit to the right through the Carry flag. A '0' is shifted into the MSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.

MOVF **Move f**

Syntax: [*label*] MOVF f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: (f) → (dest)

Status Affected: Z

Description: The contents of register f is moved to a destination dependent upon the status of d. If d = 0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flag Z is affected.

Words: 1

Cycles: 1

Example:

```
MOVF    FSR, 0
```

After Instruction
W = value in FSR register
Z = 1

35.2 Standard Operating Conditions

The standard operating conditions for any device are defined as:

Operating Voltage: $V_{DDMIN} \le V_{DD} \le V_{DDMAX}$
Operating Temperature: $T_{A\_MIN} \le T_A \le T_{A\_MAX}$

V_{DD} — Operating Supply Voltage(1)

PIC16LF18326/18346

- V_{DDMIN} (Fosc ≤ 16 MHz) ..... +1.8V
- V_{DDMIN} (Fosc ≤ 32 MHz) ..... +2.5V
- V_{DDMAX} ..... +3.6V

PIC16F18326/18346

- V_{DDMIN} (Fosc ≤ 16 MHz) ..... +2.3V
- V_{DDMIN} (Fosc ≤ 32 MHz) ..... +2.5V
- V_{DDMAX} ..... +5.5V

T_A — Operating Ambient Temperature Range

Industrial Temperature

- T_{A_MIN} ..... -40°C
- T_{A_MAX} ..... +85°C

Extended Temperature

- T_{A_MIN} ..... -40°C
- T_{A_MAX} ..... +125°C

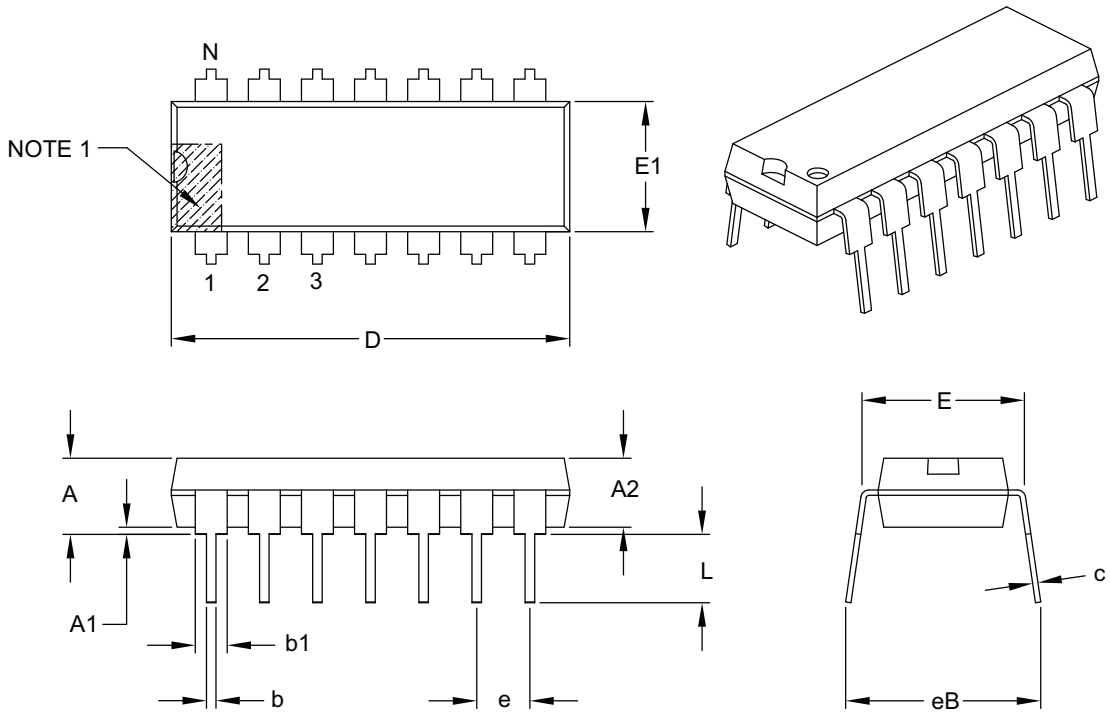
Note 1: See Parameter D002, DC Characteristics: Supply Voltage.

38.2 Package Details

The following sections give the technical details of the packages.

14-Lead Plastic Dual In-Line (P) – 300 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		14	
Pitch	e		.100 BSC	
Top to Seating Plane	A	–	–	.210
Molded Package Thickness	A2	.115	.130	.195
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.290	.310	.325
Molded Package Width	E1	.240	.250	.280
Overall Length	D	.735	.750	.775
Tip to Seating Plane	L	.115	.130	.150
Lead Thickness	c	.008	.010	.015
Upper Lead Width	b1	.045	.060	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	–	–	.430

Notes:

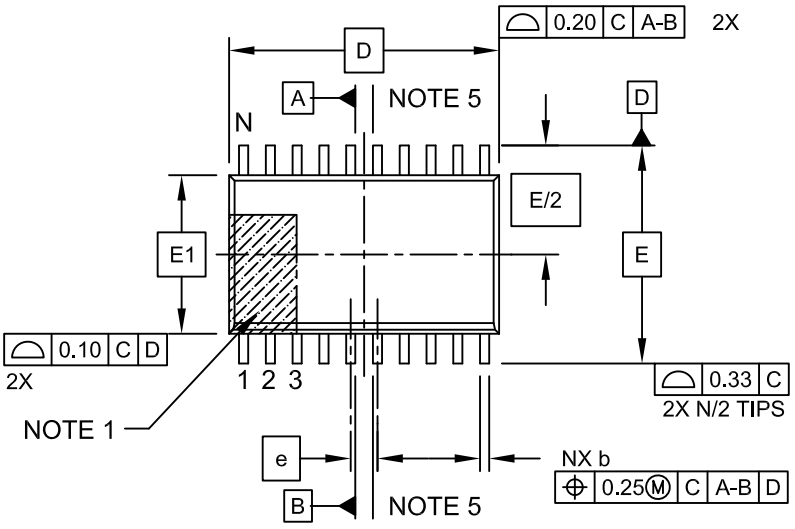
1. Pin 1 visual index feature may vary, but must be located with the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

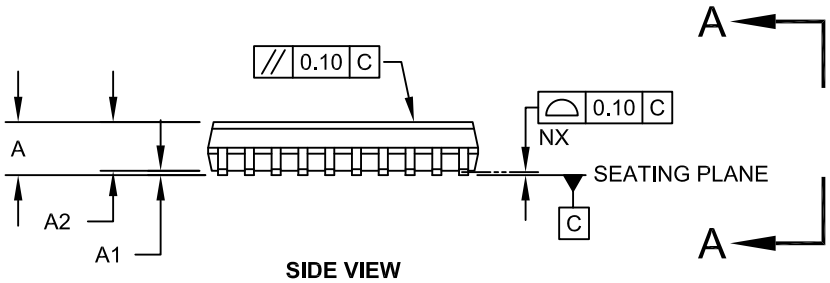
Microchip Technology Drawing C04-005B

20-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

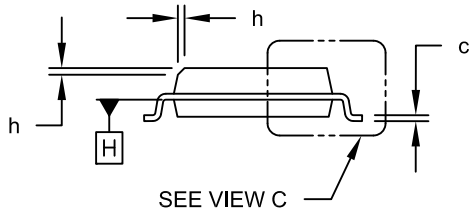
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



TOP VIEW



SIDE VIEW



VIEW A-A

Microchip Technology Drawing C04-094C Sheet 1 of 2